Panasonic

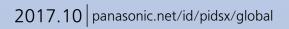
Ultra High-speed / High-precision Laser Displacement Sensor



The NO.1 industry leader

in application compatibility

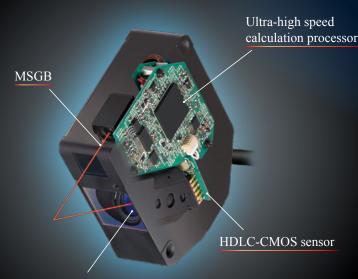
with 34 different sensor head variations



Panasonic Laser Displacement Sensors are the No. 1^{*} industry leader in application compatibility with 34 different sensor head variations

*As of May 2017, in-company survey

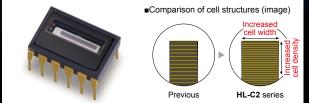




Combining our accumulated and the latest technologies to accomplished* functionality

Our proprietary measurement CMOS, the "HDLC-CMOS Sensor"

The HDLC-CMOS sensors have been developed specially for the **HL-C2** series. High density light-receiving cells and a processing speed close to the maximum limit result in high resolutions and high speeds which exceed all expectations for laser displacement sensors. HDLC: High Density Linear Cell



High-resolution lens

A diverse track record proving our products' capabilities and reliability

Since its debut, the HL-C2 series has come to be used for our customers' measurement applications in a wide variety of industries. We provide the most capable laser displacement sensors with high-speed, high-accuracy functionality to meet our customers' requests for measurement applications.

Automotive-related industries

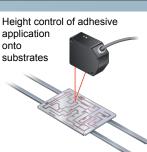






Metal / plastic / rubber industries





Thickness measurement of transparent film

measurement expertise create the most in the industry *As of May 2017, in-company survey

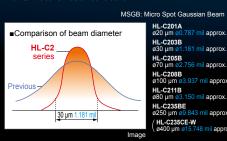


We designed a new

even higher precision

"MSGB" laser with sharp and fine projection

We have created the ideal laser using our proprietary optical technologies and aperture construction. Furthermore emission adjustment algorithms have been redesigned to maintain ideal emission conditions

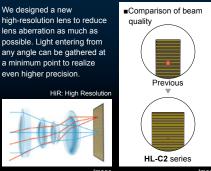


"Ultra high-speed calculation processor"

Using our specialized proprietary IC and custom algorithms for high-speed processing, information is digitally transmitted between the sensor head and controller. Both high-speed transmission and stability are realized for measurement values.

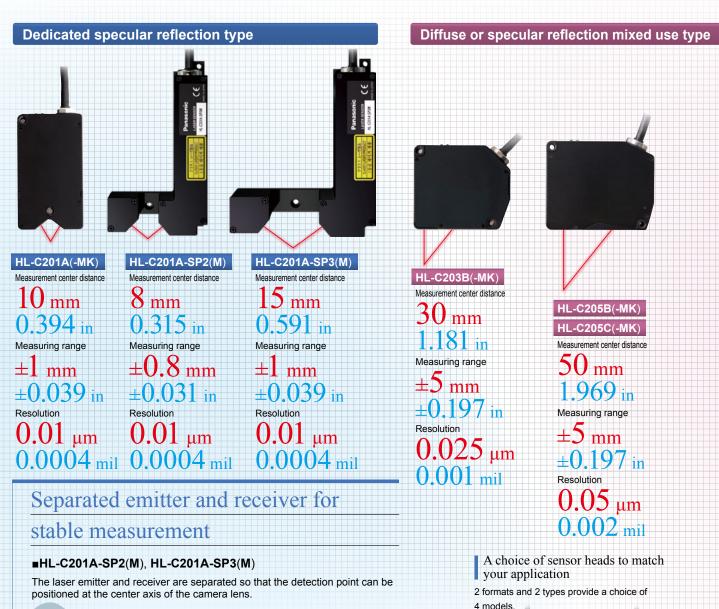


"High-resolution lens" for realizing stable optical path lengths



3

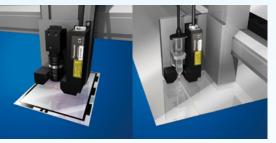
A Full Product Lineup for Meeting the Application Needs of Customers





The nozzle's drop-down point and displacement sensor's measurement point could not be placed on the same axis.

Separated construction for light emission and reception



By alingning the drop-down point and measurement point along the same axis, more stable measurements becomes possible.

50 110 1.969 4.331 (Unit: mm in) Measurement center distance: 15 mm 0.591 in • Small beam spot type HL-C201A-SP3

Measurement center

distance: 8 mm 0.315 in

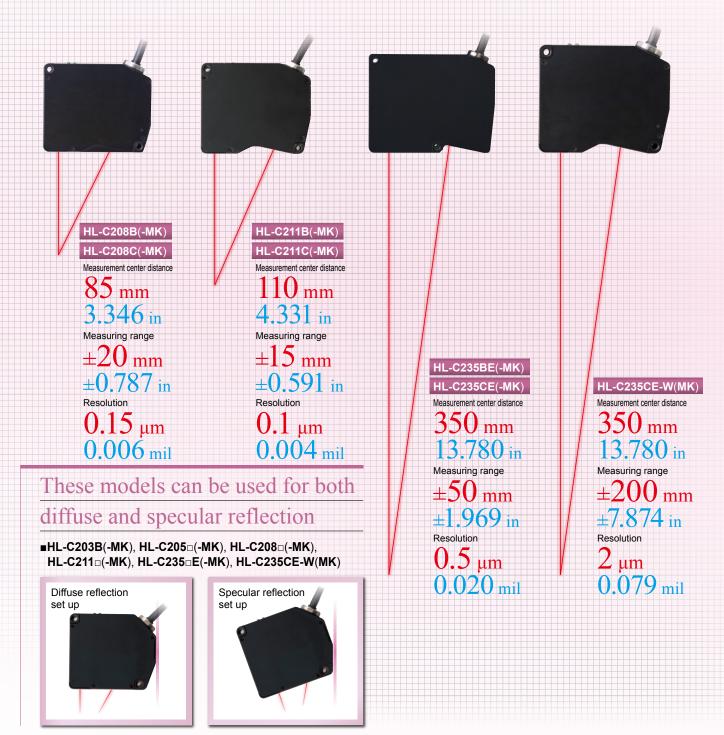
Small beam spot type HL-C201A-SP2

Linear beam spot type HL-C201A-SP2M Linear beam spot type
 HL-C201A-SP3M

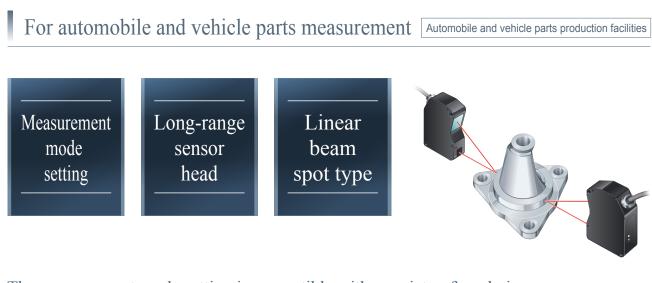
4

We brought together our accumulated measurement expertise with the latest technologies to create the world-class HL-C2 series. These sensors will meet your various short-range and long-range needs.



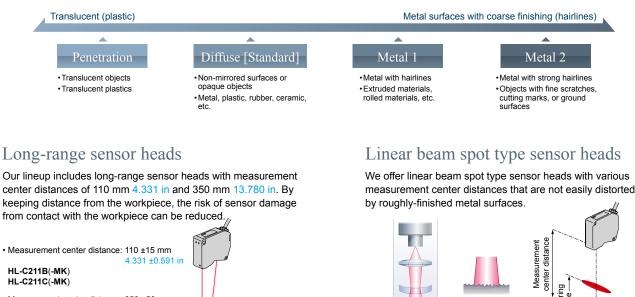


A Diverse Array of Sensor Heads for Your Application Needs



The measurement mode setting is compatible with a variety of workpieces

Select the optimal digital processing for the object to be measured.

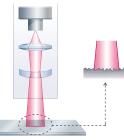


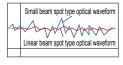
Long-range sensor heads

center distances of 110 mm 4.331 in and 350 mm 13.780 in. By keeping distance from the workpiece, the risk of sensor damage



measurement center distances that are not easily distorted

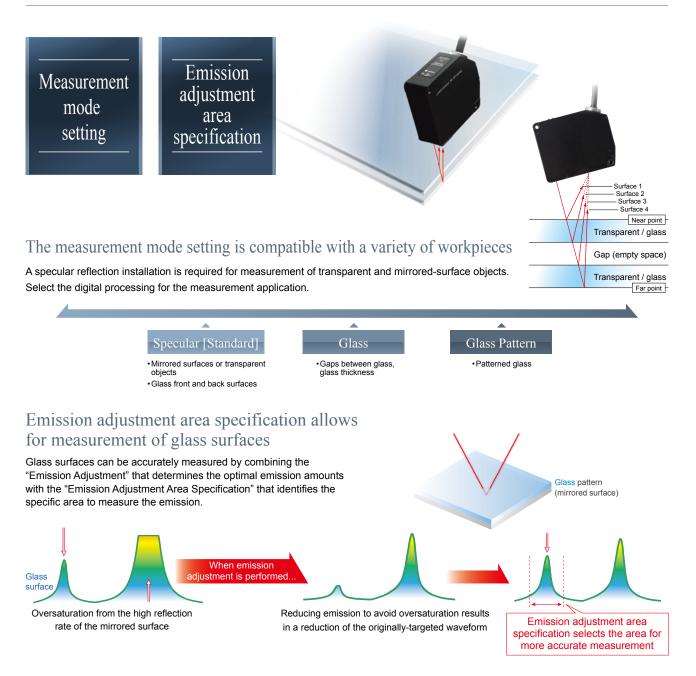




Even surfaces that appear to be flat have minor surface variations when viewed under magnification. These variations can cause errors in measurement. Linear beam spot type sensors average out the influence of these variations, allowing for stable measurement of roughly-finished workpieces.

The diverse capabilities of the HL-C2 series can be used for stable measurement with higher precision for a variety of materials.

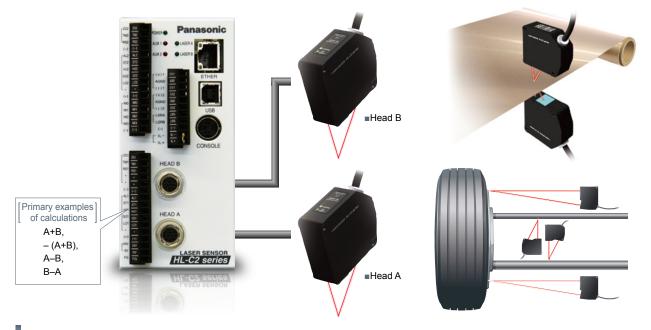
For measurement of glass height and thickness FPD and solar panel production facilities



Controllers that Provide Both Convenience and Improved Product Quality

On-board processing for calculations of 2 sensor heads

The controller is equipped to perform basic calculations and output results for applications such as thickness measurement for sandwiched layers and 2-point gap measurement. This can reduce computational burdens for host controllers (such as PLCs).



Connectivity to host controllers

Our controller lineup offers Ethernet, USB, and RS-232C connections. The controllers can connect to devices such as PCs and PLCs. *An API (Application Programming Interface) and sample programs can be downloaded for free from our web site for operating the controller using a PC connected by USB.

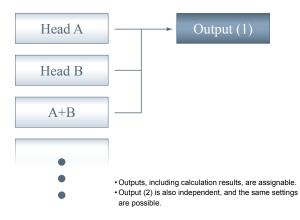


Since two sensor heads can be connected for simultaneous use, and since basic calculations optimized for applications such as thickness measurement or difference measurement are integrated in the controller, independent control is possible. Accumulating the measurement values without sacrificing high-speed sampling contributes to the high quality of the product.



A full range of output ports allows output in line with your needs

Both Output (1) and Output (2) mounted on the controller provide independent analog outputs, various output signals (judgment, alarm, etc.), and various input signals (laser emission stop, zero set, etc.).



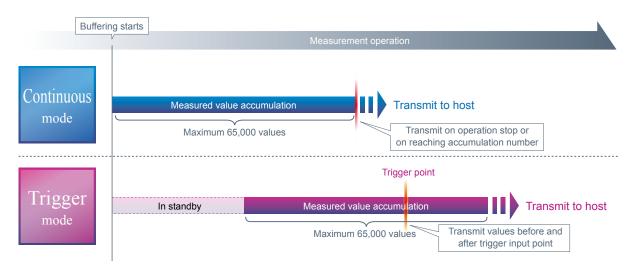
	o: Available	Output (1)	Output (2)
	Analog voltage	0	0
Output circuit	Analog current	0	0
ut ci	Hi / Go / Low judgment	0	0
Outp	Alarm	0	0
-	Strobe	0	0
cuit	Zero set	0	0
Input circuit	Timing	0	0
Inpu	Reset	0	0

*Other functions such as laser control (emission stop) input and memory change are also on-board.

Buffering function allows for temporary accumulation of measured values

The buffering function allows measurement values acquired from high-speed sampling (10 μ s) to temporarily accumulate in the controller, which are then transmitted to the host. A maximum of 65,000 values can be accumulated. The accumulation of shape data can contribute to traceability and other activities.

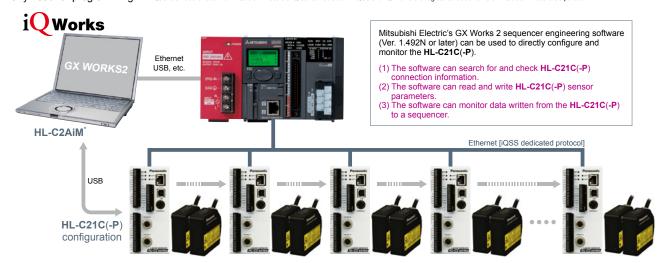
Furthermore, in trigger mode, by sending a trigger input when there is an error, measured values before and after the error can be acquired to help determine the cause of the error.



Providing Increased Connectivity and Compatibility with Host Devices

Measurement status can be acquired with a programmable controller easily and without any need for programming!

The HL-C21C(-P) supports the MEWTOCOL protocol (used by our programmable controllers), the MC protocol (used by Mitsubishi Electric's MELSEC-Q and MELSEC-L series) as well as the iQSS dedicated protocol (used by Mitsubishi Electric's MELSEC-L series), allowing measured values and other information to be written automatically to the data registers of programmable controllers without any need for programming. * iQSS is an abbreviation for Mitsubishi Electric's iQ Sensor Solution. * iQSS and iQ Works are registered trademarks of Mitsubishi Electric Corporation.

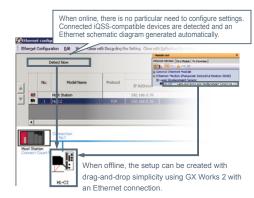


*HL-C2AiM: HL-C2 dedicated intelligent monitor (available for download free of charge on our website)

Easy setup

 $\ensuremath{\text{HL-C21C}}(\ensuremath{\text{-P}})$ connection settings can be set up using automatic detection of connected devices and drag-and-drop simplicity.

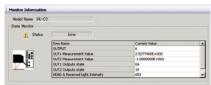
➡ Reduces development man-hours.



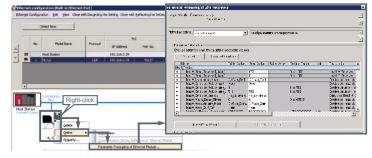
*Use Mitsubishi Electric's GX Works 2 sequencer engineering software (Ver. 1.492N or later).

Sensor monitoring

The HL-C21C(-P)'s measurement status can be easily monitored.



Reading and writing of sensor parameters HL-C21C(-P) sensor parameters can be read and written easily.



*The HL-C21C(-P)'s Ethernet communications settings must be configured using Configurator WD (Ver. 1.62 or later of our Ethernet communications configuration tool). (This software is available for download free of charge from our website.) *The MC protocol is supported for the MELSEC-Q series, and sensors can be monitored.

We offer a full range of communication interfaces for connecting to various networks along with user interfaces that allow for easy setting of high-precision operation. This allows for program-less connectivity with our own programmable controllers as well as with Mitsubishi Electric Corp. sequencers.

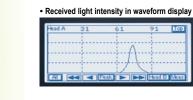
Interfaces for convenient setup and setting changes

By combining the GT12 programmable display with our software tools accessed from a PC (HL-C2AiM Intelligent Monitor), received light intensity waveforms and other information can be displayed in addition to the display of measured-value data.

GT12 Programmable Display

Simple touch panel operation and easy-to-read display

By installing screen application (provided free of charge) onto the GT12 programmable display, it can be used as a dedicated console for viewing waveforms and setting operation conditions. (A proprietary connection cable is required.)



Condition setting function





Intelligent Monitor HL-C2AiM

Waveform monitoring and function setting by computer is easy to do

*This software is available for download free of charge from our website

OS (Note 1)	: Microsoft® Windows® 7 Professional 32 bit / 64 bit Microsoft® Windows® 8 Pro 32 bit / 64 bit Microsoft® Windows® 10 Pro 32 bit / 64 bit (Japanese / English / Korean / Chinese)
CPU	: Pentium compatible CPU 1 GHz or above (Note 2)
Memory	: 2 GB or more (Note)
Hard disk	: 50 MB or more of usable space
Display screen	: SXGA (1280 × 1024 full color) or above
Serial port	: RS-232C compliant, transmission speed 115.2 kbps
USB port	: USB 2.0 full speed (USB 1.1 compatible)

Notes: 1) Windows 7 / 8 / 10 are trademarks or registered trademarks of Microsoft Corporation in the United State and other countries. 2) Depends on the OS operation environment.

Measurement value display





Light receiving intensity



Buffering display

ORDER GUIDE

Sensor heads

Туре	Appearance	Measurement center distance and	Resolution	Beam size	Model N	o. (Note)	
туре	Appearance	measuring range	(Note 1)	Dealth Size	IEC/JIS conformed type	FDA conformed type	
Small beam spot type		10 ±1 mm	0.01 µm 0.0004 mil	ø20 µm ø0.787 mil approx.	HL-C201A * (HL-C201AE *)	HL-C201F (HL-C201FE)	
Linear beam spot type	Laser sinder AL-C2 series	0.394 ±0.039 in	(0.25 µm 0.01 mil)	20 × 700 μm 27.559 mil approx.	HL-C201A-MK * (HL-C201AE-MK *)	HL-C201F-MK (HL-C201FE-MK)	
Small beam spot type		8 ±0.8 mm	0.01 µm 0.0004 mil	ø20 μm ø0.787 mil approx.	HL-C201A-SP2 (HL-C201AE-SP2)		
Linear beam spot type		0.315 ±0.031 in	(0.25 µm 0.01 mil)	20 × 700 μm 27.559 mil approx.	HL-C201A-SP2M (HL-C201AE-SP2M)		
Small beam spot type		15 ±1 mm	0.01 µm 0.0004 mil	ø30 µm ø1.181 mil approx.	HL-C201A-SP3 (HL-C201AE-SP3)		
Linear beam spot type		0.591 ±0.039 in	(0.25 µm 0.01 mil)	30 × 1,400 μm 55.118 mil approx.	HL-C201A-SP3M (HL-C201AE-SP3M)		
Small beam spot type		At diffuse reflection mode	0.025 µm 0.001 mil	ø30 µm ø1.181 mil approx.	HL-C203B * (HL-C203BE*)	HL-C203F (HL-C203FE)	
Linear beam spot type		30 ±5 mm 1.181 ±0.197 in	(0.25 µm 0.01 mil)	30 × 1,200 μm 47.244 mil approx.	HL-C203B-MK * (HL-C203BE-MK *)	HL-C203F-MK (HL-C203FE-MK)	
Small beam spot type				ø70 µm ø2.756 mil approx.	HL-C205 (HL-C20		
Linear beam spot type		At diffuse reflection mode	0.05 μm 0.002 mil	70 × 1,000 μm 39.370 mil approx.	HL-C205 (HL-C20	5 B-MK 5BE-MK)	
Small beam spot type		50 ±5 mm 1.969 ±0.197 in	(0.25 µm 0.01 mil)	ø70 μm ø2.756 mil approx.	HL-C205C (HL-C205CE)		
Linear beam spot type				70 × 1,000 μm 39.370 mil approx.	HL-C205 (HL-C20	5 C-MK 5CE-MK)	
Small beam spot type				ø100 µm ø3.937 mil approx.	HL-C208 (HL-C20		
Linear beam spot type		At diffuse reflection mode	0.15 μm 0.006 mil (0.25 μm 0.01 mil)	100 × 1,200 μm 47.244 mil approx.	HL-C208B-MK (HL-C208BE-MK)		
Small beam spot type	A.C.	85 ±20 mm 3.346 ±0.787 in		ø100 µm ø3.937 mil approx.	HL-C208 (HL-C20		
Linear beam spot type				100 × 1,200 μm 47.244 mil approx.	HL-C208 (HL-C20	8 C-MK 8CE-MK)	
Small beam				ø80 µm	HL-C211B * (HL-C211BE *)	HL-C211F (HL-C211FE)	
spot type		At diffuse reflection mode	0.1 µm 0.004 mil	ø3.150 mil approx.	HL-C211C * (HL-C211CE *)	HL-C211F5 (HL-C211F5E)	
Linear beam		110 ±15 mm 4.331 ±0.591 in	(0.25 µm 0.01 mil)	80 × 1,700 µm	HL-C211B-MK * (HL-C211BE-MK *)	HL-C211F-MK (HL-C211FE-MK)	
spot type				66.929 mil approx.	HL-C211C-MK * (HL-C211CE-MK *)	HL-C211F5-MK (HL-C211F5E-MK)	
Small beam				ø250 µm	HL-C235BE *		
spot type	• THE C 2 A STREET	At diffuse reflection mode	0.5	ø9.843 mil approx.	HL-C235CE *		
Linear beam		350 ±50 mm 13.780 ±1.969 in	0.5 μm 0.02 mil	250 × 3,500 µm	HL-C235BE-MK *		
spot type				137.795 mil approx.	HL-C235CE-MK *		
Small beam spot type		At diffuse reflection mode	2 um 0 070 mil	ø400 µm ø15.748 mil approx.	HL-C235	CE-W	
Linear beam spot type		350 ±200 mm 13.780 ±7.874 in	2 µm 0.079 mil	400 × 6,500 μm 255.905 mil approx.			

Note: Exports of models with a minimum resolution of under 0.25 μm 0.010 mil fall under Japanese Export Control defined by "Foreign Exchange and Foreign Trade Act." However, export control does not apply to the models shown in parentheses on the condition that they are used in combination with a controller (e.g. **HL-C2CE**) to which the export control defined by "Foreign Exchange and Foreign Trade Act" does not apply. In such cases, the minimum resolution is 0.25 μm 0.010 mil. Please contact us for further details.

*The product has acquired Korean S Mark certification.

ORDER GUIDE

Controllers

Тур)e	Appearance	Model No. (Note)
RS-232C	NPN output		HL-C2C * (HL-C2CE *)
compatible	PNP output		HL-C2C-P * (HL-C2CE-P *)
Ethernet	NPN output		HL-C21C (HL-C21CE)
compatible	PNP output		HL-C21C-P (HL-C21CE-P)

Note: These products have been restricted for export in accordance with the "Foreign Exchange and Foreign Trade Act". However, by combining the parts listed in parentheses with sensor heads which are not restricted for export under the "Foreign Exchange and Foreign Trade Act", products for which the act does not restrict export can be provided. Please contact us for further details.

*The product has acquired Korean S Mark certification.

OPTIONS

Programmable display

It is possible to use the programmable display as an exclusive console which enables waveform display and condition setting by installing it in the screen data (free of charge) for HL-C2.

Desig	nation	Appearance	Model No.	LCD			Communication port	Front panel color	SD memory card slot
	GT12M	GT12	Recommended AIG12MQ02D	TFT monochrome LCD (white backlight)		24 V DC	RS-232C	Pure black	_
GT12 -	GTIZIW	And the Control of Con	AIG12MQ03D	(Note 4)				Hairline silver	
GTIZ	GT12G	GT12	AIG12GQ02D	TFT monochrome LCD (green backlight)	4.6 inch			Pure black	
	61126		AIG12GQ03D	(Note 4)				Hairline silver	

Notes: 1) The screen data differs depending on the language. Please download as necessary.

2) To install the screen data in the display, prepare a PC and a USB cable (A \Leftrightarrow mini-B connector type) separately.

3) The provided console screen application has no function to write the data into or download the data from an SD memory card.

4) The backlight color becomes fixed upon the installation of provided screen application.

5) Please refer to our website for more details about programmable display GT12.

Others

Designation	Appearance	Model No.	Descr	iption					
ND filter		HL-C2F01	When the amount of reflected light is large at the time that a specular reflective sensor is installed, reducing the amount of laser light to an appropriate level enables a higher precisio measurement. (Light detection rate: 98 %) (Cannot be used with HL-C201 .)						
		HL-C2CCJ2	Length: 2 m 6.562 ft, Weight: 0.2 kg approx.						
		HL-C2CCJ5	Length: 5 m 16.404 ft, Weight: 0.4 kg approx.	Cabtyre cable with connector on both ends					
Sensor head extension cable		HL-C2CCJ10	Length: 10 m 32.808 ft, Weight: 0.7 kg approx.	Cable outer diameter: ø6.6 mm ø0.260 in Connector outer diameter: ø14.7 mm					
		HL-C2CCJ20	Length: 20 m 65.617 ft, Weight: 1.4 kg approx.	ø0.579 in max.					
		HL-C2CCJ30	Length: 30 m 98.425 ft, Weight: 2.0 kg approx.						
GT series connector cable for HL-C2		HL-C2GT-C3	Length: 3 m 9.843 ft	Cable to connect the programmable display GT12 and HL-C2 series controller					

SPECIFICATIONS

Sensor heads

o					0111	all bear	n spot	lype						
	IEC/JIS conformed type	HL-C201A(E)	HL-C201A(E)-SP2	HL-C201A(E)-SP3	HL-C2	03B(E)	HL-C2	05B(E)	HL-C2	05C(E)	HL-C2	08B(E)	HL-C2	08C(E)
tem 🖉	FDA conformed type	HL-C201F(E)			HL-C2	03F(E)	-	_	-	_	-	-		_
CE marl	king directive compliance				EMC D	rective,	RoHS D	irective						
Setup n	node (Note 2)		pecular reflectio	'n	Diffuse reflection	Specular reflection	Diffuse reflection	Specular reflection	Diffuse reflection	Specular reflection	Diffuse reflection	Specular reflection	Diffuse reflection	Specular reflection
Measur	ement center distance	10 mm 0.394 in	8 mm 0.315 in	15 mm 0.591 in	30 mm 1.181 in	26.4 mm 1.039 in	50 mm 1.969 in	46 mm 1.811 in	50 mm 1.969 in	46 mm 1.811 in	85 mm 3.346 in	81.4 mm 3.205 in	85 mm 3.346 in	81.4 mm 3.205 in
Measur	ing range (Note 3)	±1 mm ±0.039 in	±0.8 mm ±0.031 in	±1 mm ±0.039 in	±5 mm ±0.197 in	±4.6 mm ±0.181 in	±5 mm ±0.197 in	±5 mm ±0.197 in	±5 mm ±0.197 in	±5 mm ±0.197 in	±20 mm ±0.787 in	±6 mm ±0.236 in	±20 mm ±0.787 in	±6 mm ±0.236 in
Resolut [Averag (Note 4	e number of samples]	/ HL-C2 0.04 μm 0.01 μm •HL-C20 / HL-C2	1A / HL-C201A- 01A-SP3 / HL-C 0.002 mil [256] 0.0004 mil [4,03 1AE / HL-C201/ 01AE-SP3 / HL- 0.010 mil [256]	201F: , 96] AE-SP2	•HL-C203B / HL-C203F: 0.1 μm 0.004 mil [256] 0.025 μm 0.001 mil [4,096] •HL-C203BE / HL-C203FE: 0.25 μm 0.010 mil 25 μm 0.010 mil 0.25 μm 0.010 mil 0.25 μm 0.010 mil 0.25 μm 0.010 mil 2.5 μm 0.010 mil [256]					, 96] 5 CE :	•HL-C208B / HL-C208C: 0.6 μm 0.024 mil [256], 0.15 μm 0.006 mil [4,096] •HL-C208BE / HL-C208CE: 0.6 μm 0.024 mil [256], 0.25 μm 0.010 mil [4,096]			
Linearit	y (Note 6)	(HL-2	±0.02 % F.S. 01FE: ±0.025 %	5 F.S.)			±0.03	% F.S.			±0.03 % F.S.	±0.1 % F.S.	±0.03 % F.S.	±0.1 % F.S.
Tempre	rature characteristics	0.01 % F.S./°C (HL-201FE: (0.013 % F.S./°C)	0.02 %	F.S./°C	0.01 % F.S./°C									
			Rec	I semiconductor	laser (P	eak emi	ssion wa	velengtl	n: 658 n	m 0.026	mil)			
Light so	burce	Max. output: 0.1 mW Max. output: 0.3 mW				ut: 1 mW	Max. out	out: 1 mW	Max. outp	out: 5 mW	Max. outp	out: 1 mW	Max. out	out: 5 mW
	IEC/JIS conformed type	Class 1 (IEC / JIS)				EC / JIS)	Class 2 (IEC / JIS)	Class 3R	(IEC / JIS)	Class 2 (IEC / JIS)	Class 3R	(IEC / JIS)
	FDA conformed type	Class 1 [IEC / JIS / FDA (Note 7)]				2 (IEC / Class II DA)	IEC /	ss 2 JIS / Note 7)	F IEC /	s 3R JIS / Note 7)		ss 2 JIS / Note 7)	[IEC /	s 3R JIS / Note 7)
Beam s	size (Note 8)	ø20 µm ø0.78	37 mil approx.	ø30 µm ø1.18	31 mil ap	prox.	ø70 µ	ım <mark>ø2.7</mark> 8	56 mil ap	prox.	ø100	µm <mark>ø3.9</mark>	37 mil a	pprox.
Receivi	ng element				Li	near ima	age sens	or						
۶L و	aser emission			Greer	n LED (li	ghts up	during la	aser emi	ssion)					
Indicator M	easuring range	(lights up when ne	ear the measureme	ent center distance,	blinks wh		v LED the meas	uring rang	je, and lig	hts out w	hen outsi	de of the i	measuring	g range.)
ខ្លួ Pr	rotection			IP	67 (IEC	(exclud	ling the	connecto	or)					
A N	mbient temperature	0 to	+45 °C +32 to +	113 °F (No dew	condens	ation or	icing all	owed), S	Storage:	-20 to -	+70 °C –	4 to +15	58 °F	
Ar	mbient humidity			35 t	o 85 %	RH, Stor	rage: 35	to 85 %	RH					
A Jent	mbient illuminance		Inc	candescent light:	3,000 {	x or less	at the l	ght-rece	iving fac	e (Note	9)			
Environmental resistance 4 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1	bration resistance	10 to 55 H	Hz (period: 1 mir	n.) frequency, 1.5	5 mm <mark>0.(</mark>	0 <mark>59 in d</mark> o	ouble an	nplitude	in X,Y a	nd Z dire	ections f	or two h	ours ead	:h
Sł	hock resistance		196 m	/s ² acceleration	(20 G ap	prox.) ir	ו X,Y an	d Z direo	tions th	ree time	s each			
Cable				Cabtyre	cable, 0	.5 m 1.6	40 ft Ion	g with c	onnecto	r				
Cable e	extension		Extension up to total 30 m 98.425 ft is possible, with optional cable.											
Materia		Enclosure: Die-cast aluminum, Case cover: Die-cast aluminum, Front cover: Glass												
Weight				including cable)							including			
		Laser warning labels (for applicable standards and regulations): 1 set												

Notes: 1) Measuring conditions are as follows unless otherwise specified: connection with controller, supply voltage: 24V DC, ambient temperature: +20 °C +68 °F, sampling cycle: 40 µs, average number of samples: 256 times, measurement center distance, measurement object: white ceramic [aluminum vapor deposition surface reflection mirror for HL-C201A(E) / HL-C201A(E)-SP2 / HL-C201F(E), clear glass for HL-C201A(E)-SP3], and digital measurement value.

2) Use the external ND filter (optional) HL-C2F01 in case the amount of reflected beam is too large on Specular Reflection installation. (Cannot be used with HL-C201 .)

3) Measuring range at sampling periods of 20 µs and 10 µs is as follows.

5)	Measuring range at sampling periods of 20 µs and 10 µs is as follows.											
	Model I	No.	HL-C201	HL-C201D-SP2	HL-C201 -SP3	HL-C	203□	HL-C	205□	HL-C	208□	
	Setup m	ode	Specular reflection	Specular reflection	Specular reflection	Diffuse reflection	Specular reflection	Diffuse reflection	Specular reflection	Diffuse reflection	Specular reflection	
	Compling	20 µs	+0.1 to +1.0 mm +0.004 to +0.039 in	+0.1 to +0.8 mm +0.004 to +0.031 in	+0.1 to +1.0 mm +0.004 to +0.039 in	0 to +5.0 mm 0 to +0.197 in	0 to +4.6 mm 0 to +0.181 in	+0.5 to +5.0 mm +0.020 to +0.197 in	+0.5 to +5.0 mm +0.020 to +0.197 in	0 to +20 mm 0 to +0.787 in	0 to +6.0 mm 0 to +0.236 in	
	Sampling -	10 µs	+0.8 to +1.0mm +0.031 to +0.039 in	+0.7 to +0.8mm +0.028 to +0.031 in	+0.8 to +1.0mm +0.031 to +0.039 in	+3.8 to +5.0mm +0.150 in to +0.197 in	+3.6 to +4.6mm +0.142 to 0.181 in	+4.7 to +5.0mm +0.185 to +0.197 in	+4.6 to +5.0mm +0.181 to +0.197 in		Measurement not possible	

4) The P-P value for the deviation in the digital measurement values at the measurement center distance has been converted for the measurement center distance.

5) Exports of models with a minimum resolution of under 0.25 μm 0.010 mil fall under Japanese Export Control defined by "Foreign Exchange and Foreign Trade Act." These products are introduced to limited countries only. Please refer to 'PRECAUTIONS FOR PROPER USE' on p. 24.

6) Indicates error with respect to the ideal linear values for digital displacement output when standard objects were measured by our company. It may vary depending on the types of objects being measured.

8) This beam diameter is the size at the measurement center distance. These values were defined by using 1/e² (13.5 %) of the center light intensity. If there is a slight leakage of light outside the normal spot diameter and if the periphery surrounding the sensing point has a higher reflectivity than the sensing point itself, then the results may be affected.

9) Variance is ±0.03% F.S. or less depending on the ambient illuminance.

⁷⁾ FDA regulatory compliance is attained following the stipulations of Laser Notice No. 50 of FDA regulations.

SPECIFICATIONS

Sensor heads

$\overline{\ }$	Туре					Small bear	n spot type				
	을 IEC/JIS conformed type	HL-C2	11B(E)	HL-C2	11C(E)	HL-C2	235BE	HL-C2	235CE	HL-C235CE-W	
	FDA conformed type	HL-C2	11F(E)	HL-C2	11F5(E)	-	_	-	_	_	
CE n	narking directive compliance				1	AC Directive,	1			1	
Setu	p mode (Note 2)	Diffuse reflection	Specular reflection	Diffuse reflection	Specular reflection	Diffuse reflection	Specular reflection	Diffuse reflection	Specular reflection	Diffuse reflection	
Mea	surement center distance	110 mm 4.331 in	106.7 mm 4.201 in	110 mm 4.331 in	106.7 mm 4.201 in	350 mm 13.780 in	348 mm 13.701 in	350 mm 13.780 in	348 mm 13.701 in	350 mm 13.780 in	
Mea	suring range (Note 3)	±15 mm ±0.591 in	±14.5 mm ±0.571 in	±15 mm ±0.591 in	±14.5 mm ±0.571 in	±50 mm ±1.969 in	±42 mm ±1.654 in	±50 mm ±1.969 in	±42 mm ±1.654 in	±200 mm ±7.874 in	
[Ave	olution rage number of samples] e 4, 5)	HL-C21 0.1 μm •HL-C21 HL-C21	1F5 : 0.4 μm <mark>0.004 mil</mark> [4,0 1BE / HL-C2	211ČE / HL-C n 0.016 mil [2	56], :211FE /	2.0 μm 0.0	79 mil [256],	0.5 μm 0.020) mil [4,096]	8 μm 0.315 mil [256], 2 μm 0.079 mil [4,096]	
Line	arity (Note 6)		±0.03 % F.S. ±0.03 % F.S. ±0.03 % F.S. ±0.08 % F.S. (0 to +200 mm 0 to - (F.S. = ±200 mm ±7								
Tem	prerature characteristics					0.01 %	F.S./°C				
				Red semic	conductor las	er (Peak emi	ssion wavele	ngth: 658 nm	0.026 mil)		
Ligh	t source	Max. outp	out: 1 mW	Max. outp	out: 5 mW	Max. outp	out: 1 mW	Max. outp	out: 5 mW	Max. output: 5 mW	
	IEC/JIS conformed type	Class 2 (I	IEC / JIS)	Class 3R	(IEC / JIS)	Class 2 (IEC / JIS)	Class 3R	(IEC / JIS)	Class 3R (IEC / JIS)	
	FDA conformed type	Class 2 (l Class II (l	IEC / JIS), FDA)	Class 3R Class Illa	(IEC / JIS), (FDA)					Class 3R IEC / JIS / FDA (Note 7)	
Bear	m size (Note 8)		ø80 µm ø3.1	5 mil approx.		e	250 μm ø9.8	43 mil appro	х.	ø400 µm ø15.748 mil approx.	
Rece	eiving element					Linear ima	age sensor				
JO.	Laser emission				Green L	ED (lights up	during laser e	emission)			
Indicato	Measuring range	(lights up whe	n near the mea	surement center		Yellow	v LED		ts out when ou	tside of the measuring range.)	
9	Protection					(IEC) (exclud				00,	
istan	Ambient temperature	0	to +45 °C +3	32 to +113 °F	(No dew cor	ndensation or	icing allowed	d), Storage: -	-20 to +70 °C	C−4 to +158 °F	
Environmental resistance	Ambient humidity				35 to 8	5 % RH, Sto	rage: 35 to 85	5 % RH			
ienta	Ambient illuminance			Incandes	scent light: 3,	000 {x or less	at the light-r	eceiving face	e (Note 9)		
ronn	Vibration resistance	10 to 5	55 Hz (period	l: 1 min.) freq	uency, 1.5 m	m 0.059 in de	ouble amplitu	de in X,Y and	d Z directions	s for two hours each	
Envi	Shock resistance			196 m/s ² acc	eleration (20	G approx.) ir	n X,Y and Z d	lirections thre	e times each	1	
Cabl	e				Cabtyre cal	ble, 0.5 m 1.6	40 ft long wit	h connector			
Cabl	e extension	Extension up to total 30 m 98.425 ft is possible, with optional cable.									
Mate	erial	Enclosure: Die-cast aluminum, Case cover: Die-cast aluminum, Front cover: Glass									
Weig	ght	30		including cab		1	0 g approx. (300 g approx. (including cable)	
	essory					Laser warnin	g label: 1 set	-			

Notes: 1) Measuring conditions are as follows unless otherwise specified: connection with controller, supply voltage: 24V DC, ambient temperature: +20 °C +68 °F, sampling cycle: 40 μs, average number of samples: 256 times, measurement center distance, measurement object: white ceramic, and digital measurement value.

2) Use the external ND filter (optional) HL-C2F01 in case the amount of reflected beam is too large on Specular Reflection installation.

3) Measuring range at sampling periods of 20 µs and 10 µs is as follows

e) measuring i	angoat	camping periode of ze pe						
Model	No.	HL-C	211□	HL-C	235□	HL-C235CE-W		
Setup m	node	Diffuse reflection	Specular reflection	Diffuse reflection	Specular reflection	Diffuse reflection		
Carrolina	20 µs	+0.5 to +15.0 mm +0.020 to +0.591 in	+0.5 to +14.5 mm +0.020 to +0.571 in	0 to +50 mm 0 to +1.969 in	0 to +42 mm 0 to +1.654 in	-70 to +200 mm -2.756 to +7.874 in		
Sampling	10 µs	+12.5 to +15.0 mm +0.492 to +0.591 in	+12.5 to +14.5 mm +0.492 to +0.571 in	+36 to +50 mm +1.417 to +1.969 in	+36 to +42 mm +1.417 to +1.654 in	+100 to +200 mm +3.937 to +7.874 in		

4) The P-P value for the deviation in the digital measurement values at the measurement center distance has been converted for the measurement center distance.

5) Exports of models with a minimum resolution of under 0.25 µm 0.010 mil fall under Japanese Export Control defined by "Foreign Exchange and Foreign Trade Act." These products are introduced to limited countries only. Please refer to 'PRECAUTIONS FOR PROPER USE' on p. 24.

6) Indicates error with respect to the ideal linear values for digital displacement output when standard objects were measured by our company. It may vary depending on the types of objects being measured.

7) FDA regulatory compliance is attained following the stipulations of Laser Notice No. 50 of FDA regulations.

8) This beam diameter is the size at the measurement center distance. These values were defined by using 1/e² (13.5 %) of the center light intensity. If there is a slight leakage of light outside the normal spot diameter and if the periphery surrounding the sensing point has a higher reflectivity than the sensing point itself, then the results may be affected.

9) Variance is ±0.03% F.S. or less (±0.08% F.S. or less for HL-C235CE-W) depending on the ambient illuminance.

SPECIFICATIONS

Sensor heads

\searrow	Туре						m spot						1	
	볼 IEC/JIS conformed type	HL-C201A(E)-MK	HL-C201A(E)-SP2M	HL-C201A(E)-SP3M	HL-C203	B(E)-MK	HL-C205	B(E)-MK	HL-C205	C(E)-MK	HL-C208	BB(E)-MK	HL-C208	BC(E)-MK
	FDA conformed type	HL-C201F(E)-MK			HL-C203	()	-	_	-	_	-	_	-	_
CE m	arking directive compliance				r	· · · · · ·	RoHS D		D://		D.17		D://	
Setup	o mode (Note 2)		pecular reflection	1	Diffuse reflection	Specular reflection	Diffuse reflection	Specular reflection	Diffuse reflection	Specular reflection	Diffuse reflection	Specular reflection	Diffuse reflection	Specular reflection
Meas	urement center distance	10 mm 0.394 in	8 mm 0.315 in	15 mm 0.591 in	30 mm 1.181 in	26.4 mm 1.039 in	50 mm 1.969 in	46 mm 1.811 in	50 mm 1.969 in	46 mm 1.811 in	85 mm 3.346 in	81.4 mm 3.205 in	85 mm 3.346 in	81.4 mm 3.205 in
Meas	uring range (Note 3)	±1 mm ±0.039 in	±0.8 mm ±0.031 in	±1 mm ±0.039 in	±5 mm ±0.197 in	±4.6 mm ±0.181 in	±5 mm ±0.197 in	±5 mm ±0.197 in	±5 mm ±0.197 in	±5 mm ±0.197 in	±20 mm ±0.787 in	±6 mm ±0.236 in	±20 mm ±0.787 in	±6 mm ±0.236 in
[Aver	lution age number of samples] · 4, 5)	 •HL-C201A-MK / HL-C201A-SP2M / HL-C201A-SP3M / HL-C201F-MK: 0.04 μm 0.002 mil [256], 0.01 μm 0.0004 mil [4,096] •HL-C201AE-MK / HL-C201AE-SP2M / HL-C201AE-SP3M / HL-C201FE-MK: 0.25 μm 0.010 mil [256] 				+HL-C203B-MK +HL-C205B-MK / HL-C203F-MK: / HL-C205C-MK: 0.1 μm 0.004 mil [256] 0.2 μm 0.008 mil [256], 0.025 μm 0.010 mil [256] 0.05 μm 0.002 mil [4,096] /HL-C203BE-MK ·HL-C205BE-MK /HL-C203FE-MK: 0.25 μm 0.010 mil [256] 0.25 μm 0.010 mil [256] 0.25 μm 0.010 mil [256]					•HL-C208B-MK / HL-C208C-MK: 0.6 μm 0.024 mil [256], 0.15 μm 0.006 mil [4,096] •HL-C208BE-MK / HL-C208CE-MK: 0.6 μm 0.024 mil [256], 0.25 μm 0.010 mil [4,096]			
Linea	rity (Note 6)	(HL-201	±0.02 % F.S. IFE-MK: ±0.025	% F.S.)			±0.03	% F.S.			±0.03 % F.S.	±0.1 % F.S.	±0.03 % F.S.	±0.1 % F.S.
Temp	rerature characteristics	0.01 % F.S./°C (HL-201FE-MK : (0.013 % F.S./°C)	0.02 %	F.S./°C	0.01 % F.S./°C									
			Rec	semiconductor	laser (P	eak emi	ssion wa	avelengt	h: 658 n	m 0.026	mil)			
light source		Max. outpu	Max. out	out: 1 mW	Max. outp	out: 1 mW	Max. out	out: 5 mW	Max. outp	out: 1 mW	Max. out	put: 5 mW		
[IEC/JIS conformed type	Class 1 (IEC / JIS)				IEC / JIS)	Class 2 (IEC / JIS)	Class 3R	(IEC / JIS)	Class 2 (IEC / JIS)	Class 3R	(IEC / JIS)
	FDA conformed type	Class 1 [IEC / JIS / [FDA (Note 7)]				2 (IEC / Class II DA)	Class 2 [IEC / JIS / [FDA (Note 7)]		Class 3R IEC / JIS / FDA (Note 7)		Class 2 IEC / JIS / FDA (Note 7)		Class 3R IEC / JIS / FDA (Note 7)	
Bean	n size (Note 8)		20 × 700 µm 30 × 1,400 µm 30 × 1,200 µm 70 × 1,000 µm 0.787 × 27.559 mil approx. 1.181 × 55.118 mil approx. 1.181 × 47.244 mil approx. 2.756 × 39.370 mil approx.				prox.	100 × 1,200 μm 3.937 × 47.244 mil approx.						
Rece	iving element				Li	near ima	age sens	sor						
tor	Laser emission			Greer	n LED (li	ghts up	during la	aser emi	ssion)					
Indicator	Measuring range	(lights up when ne	ear the measureme	ent center distance,	blinks wh		v LED the meas	uring rang	ge, and lig	hts out w	hen outsi	de of the r	measurin	g range.)
g	Protection			IP	67 (IEC) (exclud	ding the	connecto	or)					
istar	Ambient temperature	0 to	+45 °C +32 to +	113 °F (No dew	condens	sation or	icing all	owed), S	Storage:	-20 to -	+70 °C -	-4 to +15	8 °F	
alres	Ambient humidity			35 1	o 85 %	RH, Stor	rage: 35	to 85 %	RH					
nenta	Ambient illuminance		In	candescent light	: 3,000 ł	x or less	s at the li	ight-rece	eiving fac	ce (Note	9)			
Environmental resistance	Vibration resistance	10 to 55 I	Hz (period: 1 mir	n.) frequency, 1.	5 mm <mark>0.(</mark>	059 in do	ouble an	nplitude	in X,Y a	nd Z dire	ections f	or two h	ours ead	ch
Env	Shock resistance		196 m	/s ² acceleration	(20 G ap	prox.) ir	n X,Y an	d Z direo	ctions th	ree time	s each			
Cable	9			Cabtyre	cable, 0	.5 m 1.6	640 ft Ion	g with c	onnecto	r				
Cable extension Extension up						า 98.425	ft is pos	ssible, w	ith optio	nal cable	e.			
Mate	rial		Enclosur	e: Die-cast alum	inum, C	ase cov	er: Die-c	ast alum	ninum, F	ront cov	er: Glas	s		
Weig	ht	250 g approx. (including cable) 300 g approx. (including cable)												
	ssory	Laser warning labels (for applicable standards and regulations): 1 set												
	: 1) Measuring conditions a	are as follows up			· · · ·	<u> </u>			-			noratur	a. +30 ₀	~

bets: 1) Measuring conditions are as follows unless otherwise specified: connection with controller, supply voltage: 24V DC, ambient temperature: +20 °C +68 °F, sampling cycle: 40 μs, average number of samples: 256 times, measurement center distance, measurement object: white ceramic [aluminum vapor deposition surface reflection mirror for HL-C201A(E)-MK / HL-C201A(E)-SP2M / HL-C201F(E)-MK, clear glass for HL-C201A(E)-SP3M], and digital measurement value.

2) Use the external ND filter (optional) HL-C2F01 in case the amount of reflected beam is too large on Specular Reflection installation. (Cannot be used with HL-C201 .)

3) Measuring range at sampling periods of 20 μs and 10 μs is as follows.

	Model I	No.	HL-C201 -MK	HL-C201D-SP2M	HL-C201 -SP3M	HL-C20)3□-MK	HL-C20)5□-MK	HL-C2)8□-MK
ę	Setup mode		Specular reflection	Specular reflection	Specular reflection	Diffuse reflection	Specular reflection	Diffuse reflection	Specular reflection	Diffuse reflection	Specular reflection
Sor	malina	20 µs	+0.1 to +1.0 mm +0.004 to +0.039 in	+0.1 to +0.8 mm +0.004 to +0.031 in	+0.1 to +1.0 mm +0.004 to +0.039 in	0 to +5.0 mm 0 to +0.197 in	0 to +4.6 mm 0 to +0.181 in	+0.5 to +5.0 mm +0.020 to +0.197 in	+0.5 to +5.0 mm +0.020 to +0.197 in	0 to +20 mm 0 to +0.787 in	0 to +6.0 mm 0 to +0.236 in
Sar	mpling	10	+0.8 to +1.0mm	+0.7 to +0.8mm +0.028 to +0.031 in	+0.8 to +1.0mm	+3.8 to +5.0mm	+3.6 to +4.6mm +0.142 to 0.181 in	+4.7 to +5.0mm +0.185 to +0.197 in	+4.6 to +5.0mm +0.181 to +0.197 in	+18 to +20mm +0.709 to +0.787 in	Measurement not possible

4) The P-P value for the deviation in the digital measurement values at the measurement center distance has been converted for the measurement center distance.

5) Exports of models with a minimum resolution of under 0.25 μm 0.010 mil fall under Japanese Export Control defined by "Foreign Exchange and Foreign Trade Act." These products are introduced to limited countries only. Please refer to 'PRECAUTIONS FOR PROPER USE' on p. 24.

6) Indicates error with respect to the ideal linear values for digital displacement output when standard objects were measured by our company. It may vary depending on the types of objects being measured.

7) FDA regulatory compliance is attained following the stipulations of Laser Notice No. 50 of FDA regulations.

8) This beam diameter is the size at the measurement center distance. These values were defined by using 1/e² (13.5 %) of the center light intensity. If there is a slight leakage of light outside the normal spot diameter and if the periphery surrounding the sensing point has a higher reflectivity than the sensing point itself, then the results may be affected.

9) Variance is ±0.03% F.S. or less depending on the ambient illuminance.

SPECIFICATIONS

Sensor heads

$\overline{}$	Туре	Linear beam spot type								
≧ IEC/JIS conformed type		HL-C211B(E)-MK HL-C211C(E)-MK		HL-C235BE-MK		HL-C235CE-MK		HL-C235CE-WMK		
Item 🛓	FDA conformed type			HL-C211	F5(E)-MK	(–		_		
CE ma	rking directive compliance				1	,	RoHS Direct			
Setup	mode (Note 2)	Diffuse reflection	Specular reflection	Diffuse reflection	Specular reflection	Diffuse reflection	Specular reflection	Diffuse reflection	Specular reflection	Diffuse reflection
Measurement center distance		110 mm 4.331 in	106.7 mm 4.201 in	110 mm 4.331 in	106.7 mm 4.201 in	350 mm 13.780 in	348 mm 13.701 in	350 mm 13.780 in	348 mm 13.701 in	350 mm 13.780 in
Measuring range (Note 3)		±15 mm ±0.591 in	±14.5 mm ±0.571 in	±15 mm ±0.591 in	±14.5 mm ±0.571 in	±50 mm ±1.969 in	±42 mm ±1.654 in	±50 mm ±1.969 in	±42 mm ±1.654 in	±200 mm ±7.874 in
Resolution [Average number of samples] (Note 4, 5)		 •HL-C211B-MK / HL-C211C-MK / HL-C211F-MK / HL-C211F5-MK: 0.4 μm 0.016 mil [256], 0.1 μm 0.004 mil [4,096] •HL-C211BE-MK / HL-C211CE-MK / HL-C211FE-MK / HL-C211F5E-MK: 0.4 μm 0.016 mil [256], 0.25 μm 0.01 mil [4,096] 					8 μm 0.315 mil [256], 2 μm 0.079 mil [4,096]			
Linearity (Note 6)		±0.03 % F.S.						±0.04 % F.S. (-200 to 0 mm -7.874 to 0 in), ±0.08 % F.S. (0 to +200 mm 0 to +7.874 in) (F.S. = ±200 mm ±7.874 in)		
Tempr	erature characteristics	0.01 % F.S./°C								
		Red semiconductor laser (Peak emission wavelength: 658 nm 0.026 mil)								
Light s	ource	Max. output: 1 mW Max. output: 5 mW		Max. output: 1 mW Max. output: 5 n		out: 5 mW	Max. output: 5 mW			
	IEC/JIS conformed type	Class 2 (IEC / JIS)		Class 3R (IEC / JIS)		Class 2 (IEC / JIS)		Class 3R (IEC / JIS)		Class 3R (IEC / JIS)
	FDA conformed type	Class 2 (IEC / JIS), Class II (FDA)		Class 3R (IEC / JIS), Class IIIa (FDA)						Class 3R IEC / JIS / FDA (Note 7)
Beam size (Note 8)		80 × 1,700 μm 250 × 3,500 μm 3.150 × 66.929 mil approx. 9.843 × 137.795 mil approx.			κ.	400 × 6,500 μm 15.748 × 255.905 mil approx.				
Receiv	ving element	Linear image sensor								
Γ	aser emission	Green LED (lights up during laser emission)								
Indicator	leasuring range	Yellow I ED			tside of the measuring range.					
8 Protection		IP67 (IEC) (excluding the connector)								
a istan	Ambient temperature	0 to +45 °C +32 to +113 °F (No dew condensation or icing allowed), Storage: -20 to +70 °C							–4 to +158 °F	
A les	Ambient humidity	35 to 85 % RH, Storage: 35 to 85 % RH								
Environmental resistance	Ambient illuminance	Incandescent light: 3,000 fx or less at the light-receiving face (Note 9)								
	/ibration resistance	10 to 55 Hz (period: 1 min.) frequency, 1.5 mm 0.059 in double amplitude in X,Y and Z directions						s for two hours each		
Envi	Shock resistance	196 m/s ² acceleration (20 G approx.) in X,Y and Z directions three times each								1
Cable		Cabtyre cable, 0.5 m 1.640 ft long with connector								
Cable extension		Extension up to total 30 m 98.425 ft is possible, with optional cable.								
Material		Enclosure: Die-cast aluminum, Case cover: Die-cast aluminum, Front cover: Glass								
Weight		300 g approx. (including cable) 450 g approx. (including cable) 300 g approx. (including cable)								
Acces		Laser warning labels (for applicable standards and regulations): 1 set								
					-			-		

Notes: 1) Measuring conditions are as follows unless otherwise specified: connection with controller, supply voltage: 24V DC, ambient temperature: +20 °C +68 °F, sampling cycle: 40 µs, average number of samples: 256 times, measurement center distance, measurement object: white ceramic, and digital measurement value.

2) Use the external ND filter (optional) HL-C2F01 in case the amount of reflected beam is too large on Specular Reflection installation.

3) Measuring range at sampling periods of 20 µs and 10 µs is as follows.

Mod	el No.	HL-C2 ²	11□-MK	HL-C23	HL-C235CE-WMK	
Setup	mode	Diffuse reflection	Specular reflection Diffuse reflection		Specular reflection	Diffuse reflection
Complin	20 µs	+0.5 to +15.0 mm +0.020 to +0.591 in	+0.5 to +14.5 mm +0.020 to +0.571 in	0 to +50 mm 0 to +1.969 in	0 to +42 mm 0 to +1.654 in	-70 to +200 mm -2.756 to +7.874 in
Samplin	10 µs	+12.5 to +15.0 mm +0.492 to +0.591 in	+12.5 to +14.5 mm +0.492 to +0.571 in	+36 to +50 mm +1.417 to +1.969 in	+36 to +42 mm +1.417 to +1.654 in	+100 to +200 mm +3.937 to +7.874 in

4) The P-P value for the deviation in the digital measurement values at the measurement center distance has been converted for the measurement center distance.

5) Exports of models with a minimum resolution of under 0.25 µm 0.010 mil fall under Japanese Export Control defined by "Foreign Exchange and Foreign Trade Act." These products are introduced to limited countries only. Please refer to 'PRECAUTIONS FOR PROPER USE' on p. 24.

6) Indicates error with respect to the ideal linear values for digital displacement output when standard objects were measured by our company. It may vary depending on the types of objects being measured.

7) FDA regulatory compliance is attained following the stipulations of Laser Notice No. 50 of FDA regulations.

8) This beam diameter is the size at the measurement center distance. These values were defined by using 1/e² (13.5 %) of the center light intensity. If there is a slight leakage of light outside the normal spot diameter and if the periphery surrounding the sensing point has a higher reflectivity than the sensing point itself, then the results may be affected.

9) Variance is ±0.03% F.S. or less (±0.08% F.S. or less for HL-C235CE-WMK) depending on the ambient illuminance.

SPECIFICATIONS

Controllers

0011								
\frown	Туре	RS-232C compatible	Ethernet compatible					
	NPN output type PNP output type PNP output type	HL-C2C(E)	HL-C21C(E)					
Item	PNP output type	HL-C2C(E)-P	HL-C21C(E)-P					
CE m	narking directive compliance	EMC Directive,	RoHS Directive					
Conr	nectable sensor head	Number of connectab	ole units: Max. 2 units					
Supp	bly voltage	24 V DC ±10 % including ripple 0.5 V (P-P)						
Curre	ent consumption	500 mA approx. at 2 sensor heads connected	, 350 mA approx. at 1 sensor head connected					
Sam	pling cycle	10 µs, 20 µs, 40 µs, 100 µs,	200 µs, 400 µs, 1 ms, 2 ms					
Analog output	Voltage (Note 2)	Voltage output scale: -5 to +5 V/F.S. (Output range during normal status: -1 Output at abnormal status: -10.8 V or Resolution: 2 mV, Linearity: ±0.05 % F Max. 2 mA, output impedance 50 Ω, R	0.0 to +10.Ó V +10.8 V €S.					
Analog	Current (Note 3)	Current output scale: 4 to 20 mA/F.S. (initial value) Output range during normal status: 2 to 24 mA Output at abnormal status: 1 mA or 25 mA Resolution: 3 μA, Linearity: ±0.05% F.S. Load impedance: 250 Ωmax., Response delay time: 10 μs approx.						
Alarm output		<npn output="" type=""> NPN open-collector transistor • Maximum sink current: 100 mA • Applied voltage: 30 V DC or less [between alarm output and Common(–)] • Residual voltage: 1 V or less (at 100 mA sink current)</npn>	<pnp output="" type=""> PNP open-collector transistor • Maximum source current: 100 mA • Applied voltage: 30 V DC or less (between alarm output and +V) • Residual voltage: 1 V or less (at 100 mA source current)</pnp>					
	Output operation	Opened when the amou	unt of light is insufficient					
	Short-circuit protection	Incorp	orated					
Judgment output (HI, GO, LO)		<npn output="" type=""> NPN open-collector transistor • Maximum sink current: 100 mA • Applied voltage: 30 V DC or less [between judgment output to Common(–)] • Residual voltage: 1 V or less (at 100 mA sink current)</npn>	<pnp output="" type=""> PNP open-collector transistor • Maximum source current: 100 mA • Applied voltage: 30 V DC or less (between judgment output to +V) • Residual voltage: 1 V or less (at 100 mA source current)</pnp>					
	Output operation	Opened at output operation						
	Short-circuit protection	Incorporated						
Strobe output		<npn output="" type=""> NPN open-collector transistor • Maximum sink current: 100 mA • Applied voltage: 30 V DC or less [between strobe output to Common(-)] • Residual voltage: 1 V or less (at 100 mA sink current)</npn>	<pnp output="" type=""> PNP open-collector transistor • Maximum source current: 100 mA • Applied voltage: 30 V DC or less (between strobe output to +V) • Residual voltage: 1 V or less (at 100 mA source current)</pnp>					
	Output operation	Opened at data determination						
	Short-circuit protection	Incorporated						
Remote interlock input		<npn output="" type=""> Laser emission is delayed when connected to Common (–). Laser emission stop at open Applied voltage: 30 V DC or less (Leak current: 0.1 mA or less)</npn>	<pnp output="" type=""> Laser emission is delayed when connected to IL (+). Laser emission stop at open Applied voltage: 30 V DC or less (Leak current: 0.1 mA or less)</pnp>					
Laser control input		<npn output="" type=""> Laser emission is stopped when connected to Common (–). Laser is emitted immediately after opened. Applied voltage: 30 V DC or less (Leak current: 0.1 mA or less)</npn>	<pnp output="" type=""> Laser emission is stopped when connected to external power (+). Laser is emitted immediately after opened. Applied voltage: 30 V DC or less (Leak current: 0.1 mA or less)</pnp>					
Zero set input		<npn output="" type=""> Zero set is ON when connected with Common (–). Zero set turns to OFF after continuously connected to Common (–) for one second. Applied voltage: 30 V DC or less (Leak current: 0.1 mA or less)</npn>	<pnp output="" type=""> Zero set is ON when connected with external power (+). Zero set turns to OFF after continuously connected to external power (+) for one second. Applied voltage: 30 V DC or less (Leak current: 0.1 mA or less)</pnp>					
Timing input		<npn output="" type=""> ON at/during connection to Common (–) (depending on analysis mode) Applied voltage: 30 V DC or less (Leak current: 0.1 mA or less)</npn>	<pnp output="" type=""> ON at/during connection to external power (+) (depending on analysis mode) Applied voltage: 30 V DC or less (Leak current: 0.1 mA or less)</pnp>					
Reset input		<npn output="" type=""> Reset is done when connected to Common (–). Applied voltage: 30 V DC or less (Leak current: 0.1 mA or less)</npn>	<pnp output="" type=""> Reset is done when connected to external power (+). Applied voltage: 30 V DC or less (Leak current: 0.1 mA or less)</pnp>					
Memory change input		<npn output="" type=""> Memory is specified when connected to Common (–). Applied voltage: 30 V DC or less (Leak current: 0.1 mA or less) Applied voltage: 30 V DC or less (Leak current: 0.1 mA or less)</npn>						
wem		Baud rate 9,600, 19,200, 38,400, 115,200 bit/s —						
	232C interface	Baud rate 9,600, 19,200, 38,400, 115,200 bit/s	—					
RS-2	232C interface rnet interface (Note 4)	Baud rate 9,600, 19,200, 38,400, 115,200 bit/s —						
RS-2 Ether		_	Compatible protocols: iQSS-compatible proprietary protocol,					

SPECIFICATIONS

Controllers

\sim	Туре		RS-232C compatible	Ethernet compatible				
	Model No.	NPN output type	HL-C2C(E)	HL-C21C(E)				
Iten	n / B	PNP output type	HL-C2C(E)-P	HL-C21C(E)-P				
	Power Sensor head A Laser radiation		Green LED (lights up at power on)					
Ŀ			Green LED (lights up during or immediately before laser emission of sensor head A)					
Indicator	Sensor head B Laser radiation		Green LED (lights up during or immediately before laser emission of sensor head B)					
	Alarm 1		Red LED (lights up when OUT1 can not be measured due to insufficient amount of light)					
	Alarm 2		Red LED (lights up when OUT2 can not be measured due to insufficient amount of light)					
tance	Ambient temperature Ambient humidity Vibration resistance Shock resistance		0 to +50 °C +32 to +122 °F (No dew condensation or icing allowed), Storage: -20 to +70 °C -4 to +158 °F					
al resist			35 to 85 %RH					
nment			10 to 55 Hz frequency (period: 1 min.), 0.75 mm 0.030 in double amplitude in X, Y and Z directions for 30 min. each					
Enviro	Shock res	istance	196 m/s ² acceleration (20G approx.) in X, Y, and Z directions three times each					
Material			Case: Polycarbonate					
Wei	Weight		450 g approx.					
Accessory			CD-ROM: 1 pc., USB cable (2 m 6.562 ft long): 1 pc., Short bracket: 1 pc. CD-ROM: 1 pc., USB cable (2 m 6.562 ft long): 1 pc., Short bracket Ferrite core (E04SR200935A made by Seiwa Electric Mfg. Co.): 3 c					

Notes: 1) HL-C2C(-P) / HL-C21C(-P) are restricted for export in accordance with the "Foreign Exchange and Foreign Trade Law". These products are introduced to limited countries only. Please refer to 'PRECAUTIONS FOR PROPER USE' on p. 24.

2) The linearity is F.S.=20 V to digital measurement value. Response delay time is the period after update of measurement value.

3) The linearity is F.S.=16 mA to digital measurement value. Response delay time is the period after update of measurement value.

4) For Ethernet communication settings of HL-C21C(E) (-P), Configurator WD (Ethernet communication setting tool, Ver. 1.62 or later) is required. Please download it from our website for use.

I/O CIRCUIT AND WIRING DIAGRAMS

Terminal arrangement

Terminal block 2	Terminal block 1		Termin	al block 2	Terminal block 3	
Terminal block 1	Terminal	Function	Terminal	Function	Terminal	Function
	NPN PNP		NPN PNP		NPN PNP	
RETENSION ANY O LASER A	(V)1	Analog voltage output (for OUT1)	ZS2	Zero set input (for OUT2) ON during short circuit (Note 1)	ZS1	Zero set input (for OUT1) ON during short circuit (Note 1)
	AGND	Analog ground		Timing input (for OUT2) ON		Timing input (for OUT1) ON
	(I)1	Analog current output (for OUT1)	TM2	during short circuit	TM1	during short circuit
	(V)2	Analog voltage output (for OUT2)	RS2	Reset input (for OUT2) ON during short circuit	RS1	Reset input (for OUT1) ON during short circuit
	AGND	Analog ground	(-)	Common (–)		Reserved terminal (Note 2)
	(I)2	Analog current output (for OUT2)				· · · · ·
HEAD B	LSRA	Laser control input (for Head A)	AL2	Alarm output (for OUT2)	•	Reserved terminal (Note 2)
		Laser stop during short circuit	ST2	Strobe output (for OUT2)	(-)	Common (–)
	LSRB	Laser control input (for Head B) Laser stop during short circuit	HI2	Judgment HI output (for OUT2)	AL1	Alarm output (for OUT1)
	(-)	Common (–)	GO2	Judgment GO output (for OUT2)	ST1	Strobe output (for OUT1)
		Remote interlock Laser stop	LO2	Judgment LO output (for OUT2)	HI1	Judgment HI output (for OUT1)
	IL IL-	when opened.	•	Reserved terminal (Note 2)	GO1	Judgment GO output (for OUT1)
Terminal block 3	(-) IL+	Remote interlock common	(-) (+)	Common (–) / Common (+)	LO1	Judgment LO output (for OUT1)
			M0		•	Reserved terminal (Note 2)
			M1	Memory change (16 ways)	(-) (+)	Common (–) / Common (+)
			M2	Memory enange (10 ways)	24V	24 V DC input for power supply

М3

(-)

Notes: 1) Turn off the terminal in case short circuit lasts for more than one second.

Common (-)

2) Do not connect anything to the reserved terminals.

short circuit lasts for more than one second.2) Do not connect anything to the reserved terminals.

Power supply ground 0 V

Frame ground

Notes: 1) Turn off the terminal in case

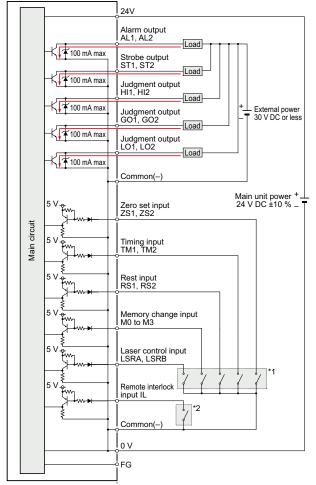
0V

FG

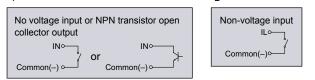
I/O CIRCUIT AND WIRING DIAGRAMS

NPN output type

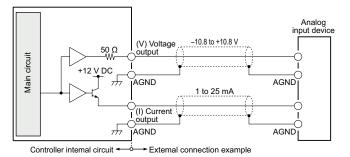
I/O circuit diagrams

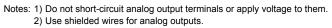


Controller internal circuit ← È → External connection example *1 *2



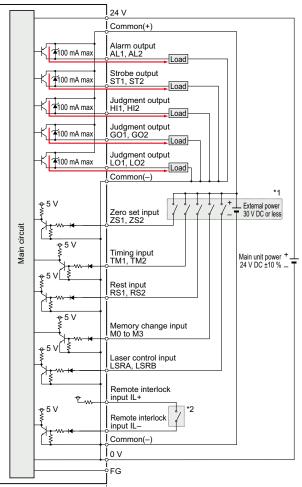
Analog output (Common in NPN output type and PNP output type)



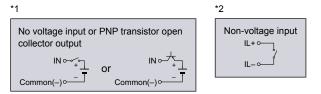


PNP output type

I/O circuit diagrams



Controller internal circuit - External connection example

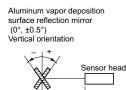


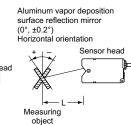
SENSING CHARACTERISTICS (TYPICAL)

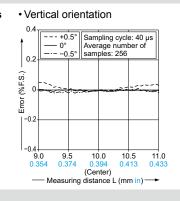
HL-C201A HL-C201F

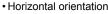
Correlation between measuring distance and error characteristics

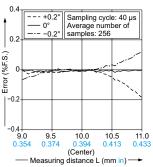
Setup mode: Specular reflection











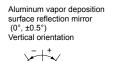
HL-C201A-SP2

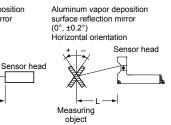
Measuring

object

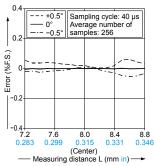
Correlation between measuring distance and error characteristics

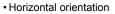
Setup mode: Specular reflection

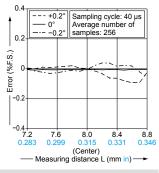




Vertical orientation







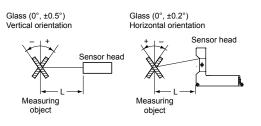
HL-C201A-SP3

Measuring

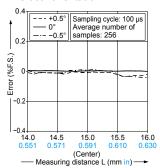
object

Correlation between measuring distance and error characteristics

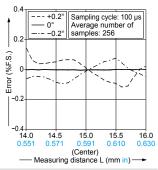
Setup mode: Specular reflection



Vertical orientation



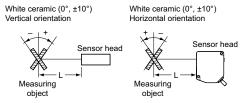
· Horizontal orientation



HL-C203B HL-C203F

Correlation between measuring distance and error characteristics

Setup mode: Diffuse reflection



Setup mode: Specular reflection

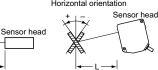
Aluminum vapor deposition surface reflection mirror $(0^{\circ}, \pm 0.5^{\circ})$ Vertical orientation

Ê

Measuring

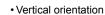
object

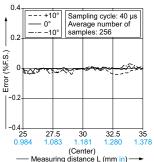
Aluminum vapor deposition surface reflection mirror (0°, ±0.2°) Horizontal orientation



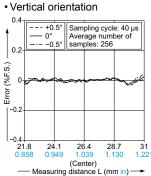
Measuring

object

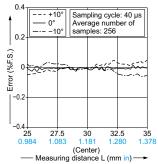


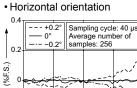


Measuring distance L (m



Horizontal orientation





Error

-0.2

-0.4

21.8

0.858

24.1

0.949

28.7

1.130

31 1.22

26.4

(Center)

HL-C2 SENSING CHARACTERISTICS (TYPICAL)

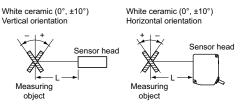
HL-C205B HL-C205C

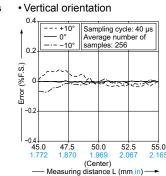
Correlation between measuring distance and error characteristics

Setup mode: Diffuse reflection

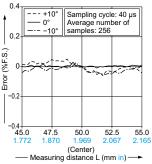
Setup mode: Specular reflection

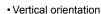
Sensor he

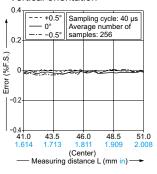




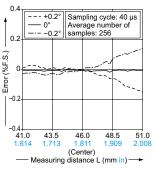
Horizontal orientation







Horizontal orientation



HL-C208B HL-C208C

Glass (0°, ±0.5°) Vertical orientation

A

Measuring

object

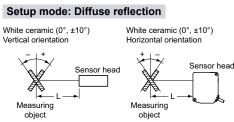
Correlation between measuring distance and error characteristics

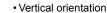
Measuring

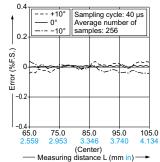
object

Glass (0°, ±0.2°) Horizontal orientation

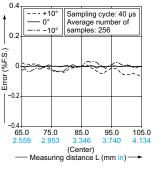
Sensor head

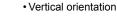


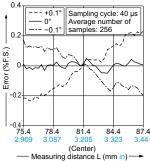


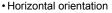


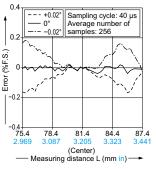
Horizontal orientation

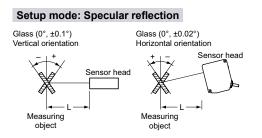














SENSING CHARACTERISTICS (TYPICAL)

HL-C211B HL-C211C HL-C211F HL-C211F5

Correlation between measuring distance and error characteristics

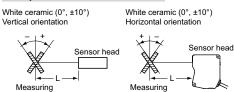
object

Aluminum vapor deposition

surface reflection mirror

(0°, ±0.05°)

Setup mode: Diffuse reflection



Vertical orientation

Vertical orientation

+0.1

• 0

0.4

0.2

0

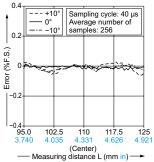
-0.2

-0.4 92.2

3.630

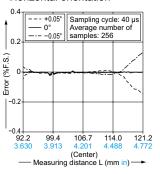
· (%F.S.)

Error



Sampling cycle: 40 µs Average number of samples: 256

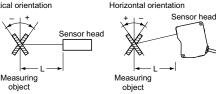
Horizontal orientation



Setup mode: Specular reflection

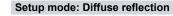
Aluminum vapor deposition surface reflection mirror (0°, ±0.1°) Vertical orientation

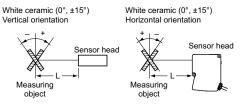
object



HL-C235BE HL-C235CE

Correlation between measuring distance and error characteristics





Vertical orientation

99.4

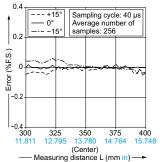
106.7

(Center)

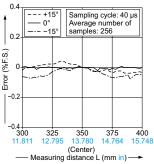
Measuring distance L (mm in)

114.0

121.2



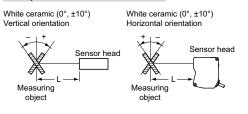
Horizontal orientation



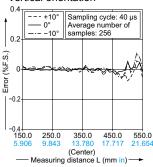
HL-C235CE-W

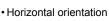
Correlation between measuring distance and error characteristics

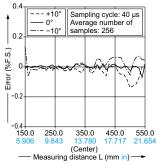
Setup mode: Diffuse reflection











PRECAUTIONS FOR PROPER USE

- This catalog is a guide to select a suitable product. Be sure to read instruction manual attached to the product prior to its use.
 - Never use this product as a sensing device for personnel protection.



- In case of using sensing devices for personnel protection, use products which meet laws and standards, such as OSHA, ANSI or IEC etc., for personnel protection applicable in each region or country.
- Do not use in environments with flammable gases. Usage may cause an explosion.
- Do not operate products using methods other than those described in the instruction manual included with each product. Control or adjustment through procedures other than those specified may cause hazardous laser radiation exposure.



- The following labels are attached to the products. Handle each product according to the instruction given on the warning label.
- Types which comply with FDA regulations have an English label applied based on those FDA regulations.

HL-C201A(E)(-MK) / HL-C201A(E)-SP2(M) / HL-C201A(E)-SP3(M)

 This product is classified as a Class 1 Laser Product in IEC / JIS standards. Do not look at the laser beam through optical devices such as a lens.



HL-C203B(E)(-MK) / HL-C205B(E)(-MK) / HL-C208B(E)(-MK) / HL-C211B(E)(-MK) / HL-C235BE(-MK)

 This product is classified as a Class 2 Laser Product in IEC / JIS standards. Do not look at the laser beam directly or through optical devices such as a lens.

HL-C205C(E)(-MK) / HL-C208C(E)(-MK) / HL-C211C(E)(-MK) / HL-C235CE(-MK) / HL-C235CE-W(-MK)

• This product is classified as a Class 3R Laser Product in IEC / JIS standards. Never directly look at or touch the laser beam or its reflection.



- Do not use outside of specification ranges for ratings, environmental conditions, etc. Abnormal heat or smoke generation may occur.
- Do not disassemble or modify these products. Electrical shock or smoke generation may occur.
- Connect electrical wires securely with terminal screws. Imperfect connections may cause abnormal heat or smoke generation.
- Do not touch the terminal while power is being supplied to the product. Electrical shock may occur.

• Exports of models with a minimum resolution of under 0.25 μ m 0.010 mil fall under Japanese Export Control, which is defined by "Foreign Exchange and Foreign Trade Act".

Therefore, anyone who wishes to export or transfer these products outside of Japan is required to obtain the necessary license from the Ministry of Economy, Trade and Industry of Japan.

Also, these products fall under international export control regulations, such as Nuclear Suppliers Group (NSG) guidelines 1.B.3.b.1 and Wassenaar Arrangement (WA) 2.B.6.b.1.a, and are objects of the regulation. Please comply with the export control in each country.

Note: These products are introduced to limited countries only. Please contact our office for details.

Warming up time

• To ensure the performance of the product, before use allow at least 30 minutes of warming up after turning on the power.

Safety standards for laser beam products

• A laser beam can harm human being's eyes, skin, etc., because of its high energy density. IEC and JIS have classified laser products according to the degree of hazard and the stipulated safety requirements.

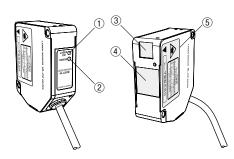
Safe use of laser products

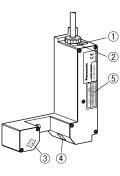
• For the purpose of preventing users from suffering injuries by laser products, IEC 60825-1(Safety of laser products). Please check the standards before use.

PRECAUTIONS FOR PROPER USE

Fuctional description

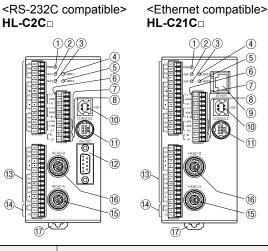
Sensor head





	Description	Function
1	Laser emission indicator (Green LED)	Lights up during laser emission.
2	Measurement range indicator (Yellow LED)	Lights up when the target reaches the approximate center of the measurement. Blinks when the target enters within the measurement range. Turns off the light when the target goes out of the measurement range.
3	Light emitter	Emits the laser light.
4	Light receiver	Receives the laser specular light from a measurement target.
5	Warning label	Shows the laser emission position. Please read carefully before use.

Controller

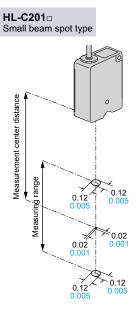


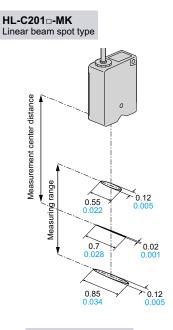
	Description	Function
1	POWER indicator	Lights up in green when electricity is provided to the controller.
2	ALM1 (Alarm) indicator	Abnormal condition indicator for OUT1. Lights up in red during dark status (poor light intensity) of OUT1 or the sensor head is in unconnected status.
3	ALM2 (Alarm) indicator	Abnormal condition indicator for OUT2. Lights up in red during dark status (poor light intensity) of OUT2 or the sensor head is in unconnected status.
4	LASER A indicator	Lights up in green during the laser radiation of Head A.
(5)	LASER B indicator	Lights up in green during the laser radiation of Head B.
6	Analog output terminal	Terminal for analog data output.
7	Laser control terminal	Stops laser emission in case of short-circuiting.
8	Remote interlock terminal	Stops laser emission when it's opened.
9	Ethernet connector	Equipped on HL-C21C models. Used for Ethernet communication with controllers.
10	USB connector	Used for communication with PC using USB.
1	Console connection connector	Used for connecting the console.
12	RS-232C connector	Equipped on HL-C2C models. Used for RS-232C communication with controllers.
13	I/O terminal	Terminal for various I/O and memory change.
14	Power terminal	Terminal for power supply to the controller.
15	Sensor head A connection connector	Controller recognizes a sensor head which is connected to this connector as "Sensor head A" and starts operation.
16	Sensor head B connection connector	Controller recognizes a sensor head which is connected to this connector as "Sensor head B" and starts operation.
17	DIN rail mounting hook	Used for hooking / removing the sensor heads to / from the 35 mm 1.378 in width DIN rail with one-touch simple operation.

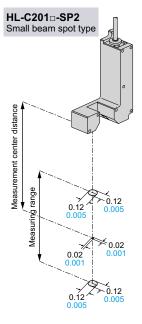
Note: In case of connecting one sensor head to the controller, be sure to connect the sensor head to (5) the sensor head A connection (HEAD A) side. If the sensor head is connected to (6) the sensor head B connection (HEAD B) side, the measurement cannot be performed.

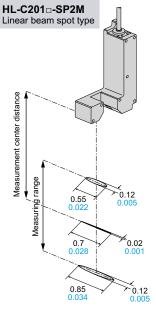
PRECAUTIONS FOR PROPER USE

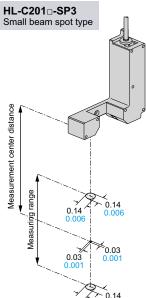
Beam size (Unit: mm in)

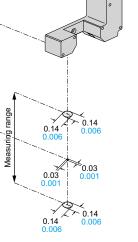


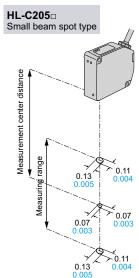


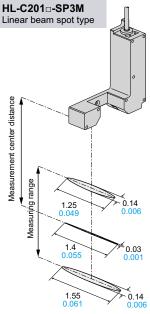




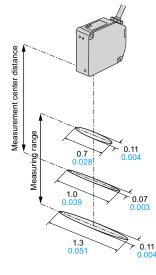




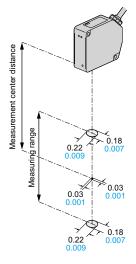




HL-C205 -MK Linear beam spot type







HL-C208

Measurement center distance

range

ing.

Measu

0.4 0.016

0.1 0.004

0.4 0.016

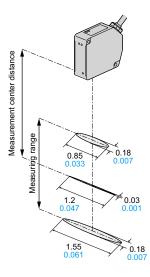
> 0.25

>0.1 0.004

0.25 0.01

Small beam spot type





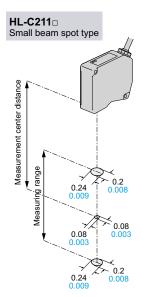
HL-C208 -- MK Linear beam spot type Measurement center distance Measuring range 7 0.25 0.4 0.016 1.2 ≻0.1 0.004 2.0 0.079 $> \frac{0.25}{0.01}$

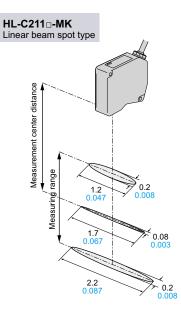
PRECAUTIONS FOR PROPER USE

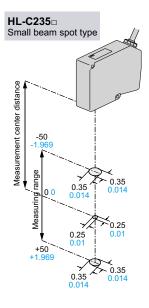
Refer to the instruction manual for details. The instruction manual can be download from our website.

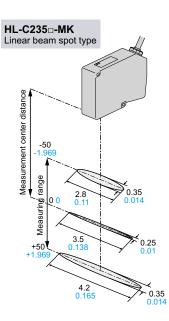
0.8

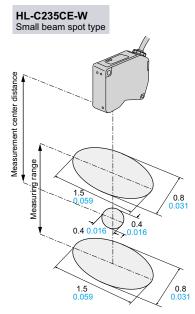
Beam size (Unit: mm in)

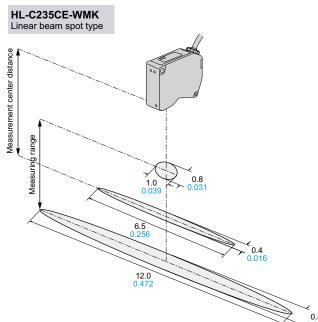








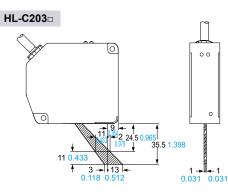


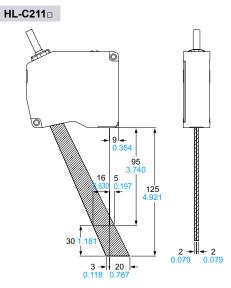


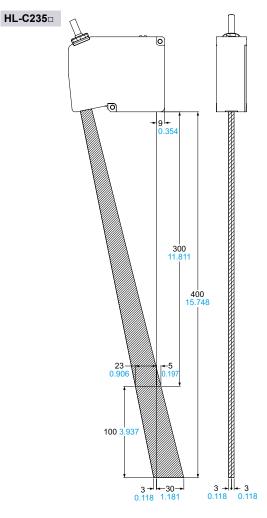
PRECAUTIONS FOR PROPER USE

Mutual interference (Unit: mm in)

• When installing two or more sensor heads side by side, mutual interference will not occur if the laser spots from other sensor heads do not fall within the shaded areas in the figure below. When connecting two sensor heads to one controller, the mutual interference prevention function can be used. Therefore the measures shown below are not necessary in that case.

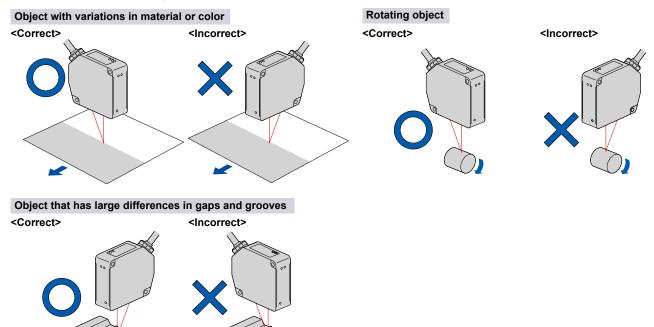






Sensor head mounting direction

• To obtain the greatest precision, the sensor head should be oriented facing the direction of movement of the object's surface, as shown in the figure below.



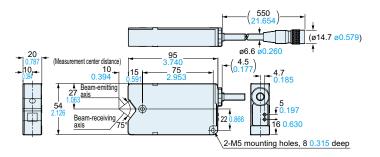
Sensor head

DIMENSIONS (Unit: mm in)

The CAD data can be downloaded from our website.

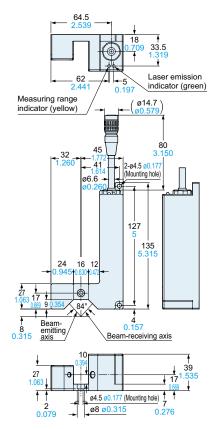
HL-C201 HL-C201 -MK

Setup mode: Specular reflection type



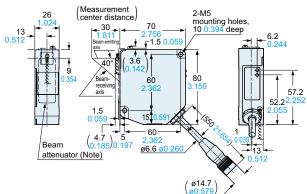
HL-C201 -- SP2 HL-C201 -- SP2M

Setup mode: Specular reflection type



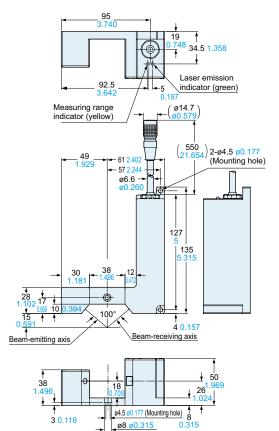
HL-C203 HL-C203 -MK

Setup mode: Diffuse reflection type



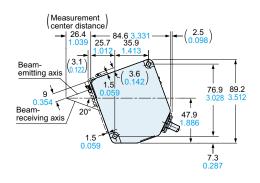
Setup mode: Specular reflection type

HL-C201 -- SP3 HL-C201 -- SP3M



Sensor head

Setup mode: Specular reflection type



DIMENSIONS (Unit: mm in)

The CAD data can be downloaded from our website.

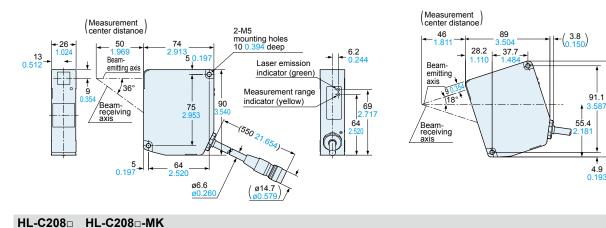
HL-C205 HL-C205 -MK

Setup mode: Diffuse reflection type

Setup mode: Diffuse reflection type

Setup mode: Specular reflection type

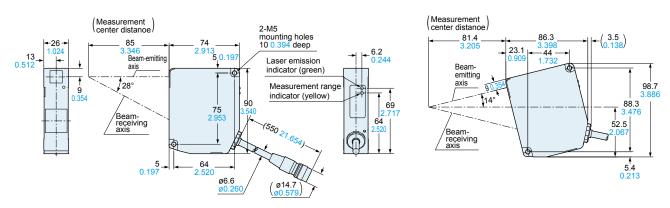
Setup mode: Specular reflection type



Sensor head

101 3.97

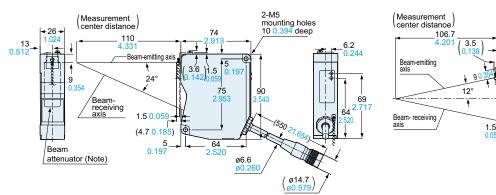
Sensor head



HL-C211 HL-C211 -MK

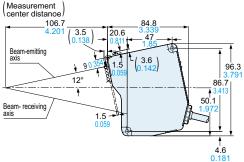
Setup mode: Diffuse reflection type

Sensor head



Note: A beam attenuator is not available for JIS / IEC conformed types.

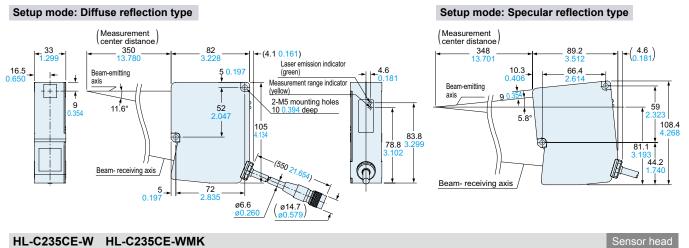
Setup mode: Specular reflection type



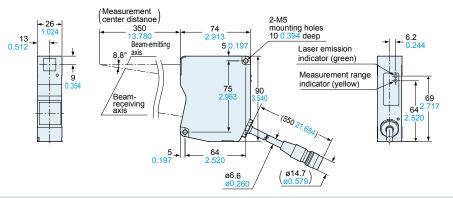
DIMENSIONS (Unit: mm in)

The CAD data can be downloaded from our website.

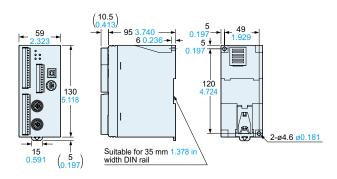
HL-C235 HL-C235 -MK



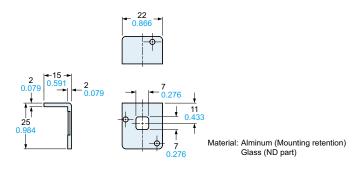
HL-C235CE-W HL-C235CE-WMK



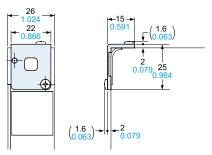
HL-C2C HL-C21C



HL-C2F01



Mounting drawing with a sensor head



Notes: 1) HL-C201 a cannot be mounted.

2) For HL-C235 (-MK) models, mounting is on 2 places on the front panel.

3) Cannot be attached to FDA conformed types when a beam attenuator is in use.

Sensor head

ND filter

Introduction to our Laser Displacement Sensors and Micro Laser Distance Sensors

FDA

Laser Displacement Sensor Compact (€

Precision measurement with a resolution of 0.5 µm 0.02 mil (HL-G103□). On-board controller for easy integration with other devices and production lines

A full range of models are available! We offer 10 diffuse reflection type models (Class 2) and 6 specular reflection type models (Class 1). These products excel in a variety of applications.



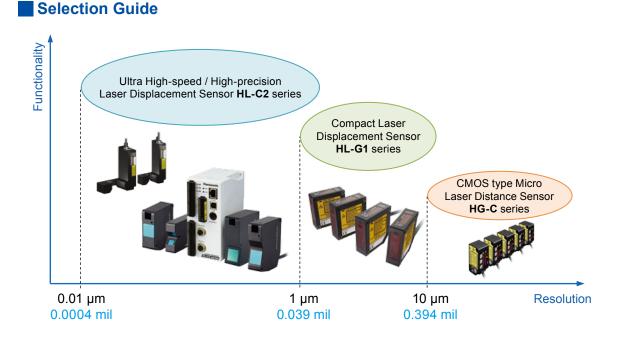
Micro Laser Distance Sensor CMOS type CE FDA

We have created CMOS laser sensor with a repeatable precision of 10 μ m 0.394 mil for stable detection operation.

This product offers high-precision detection comparable to more expensive displacement sensors. It has an even smaller form-factor design, greater ease of installation, and a low price for competitive cost-performance. It can be used in equipment for working with circuit boards, in automobile assembly, and in various assembly and inspection processes.

- Repeatable precision of 10 µm 0.394 mil (HG-C1030)
- Compact size of W20 × H44 × D25 mm
- Uses an inflection resistant cable





Disclaimer

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